

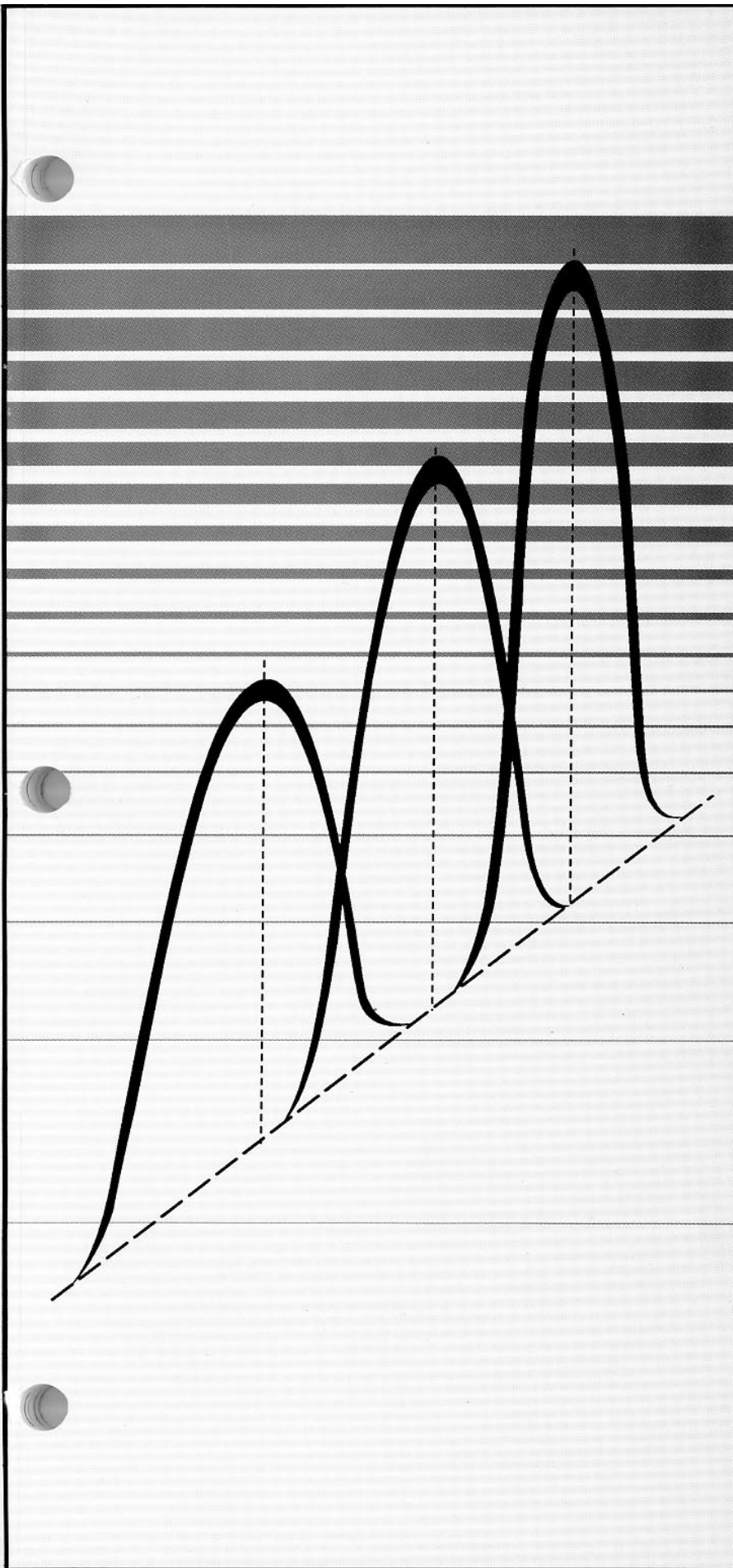
ANSI/IPC-PC-90

Original Publication October 1990

**General
Requirements
for
Implementation
of
Statistical
Process
Control**



Developed by the
**INSTITUTE FOR INTERCONNECTING
AND PACKAGING ELECTRONIC CIRCUITS**



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Any standard involving a complex technology draws material from a vast number of sources. While the principle members of the IPC Statistical Process Control Subcommittee of the IPC Process Control Management Committee are shown below, it is not possible to include all of those who assisted in the evolution of this Standard. To each of them, the members of the IPC extend their gratitude.

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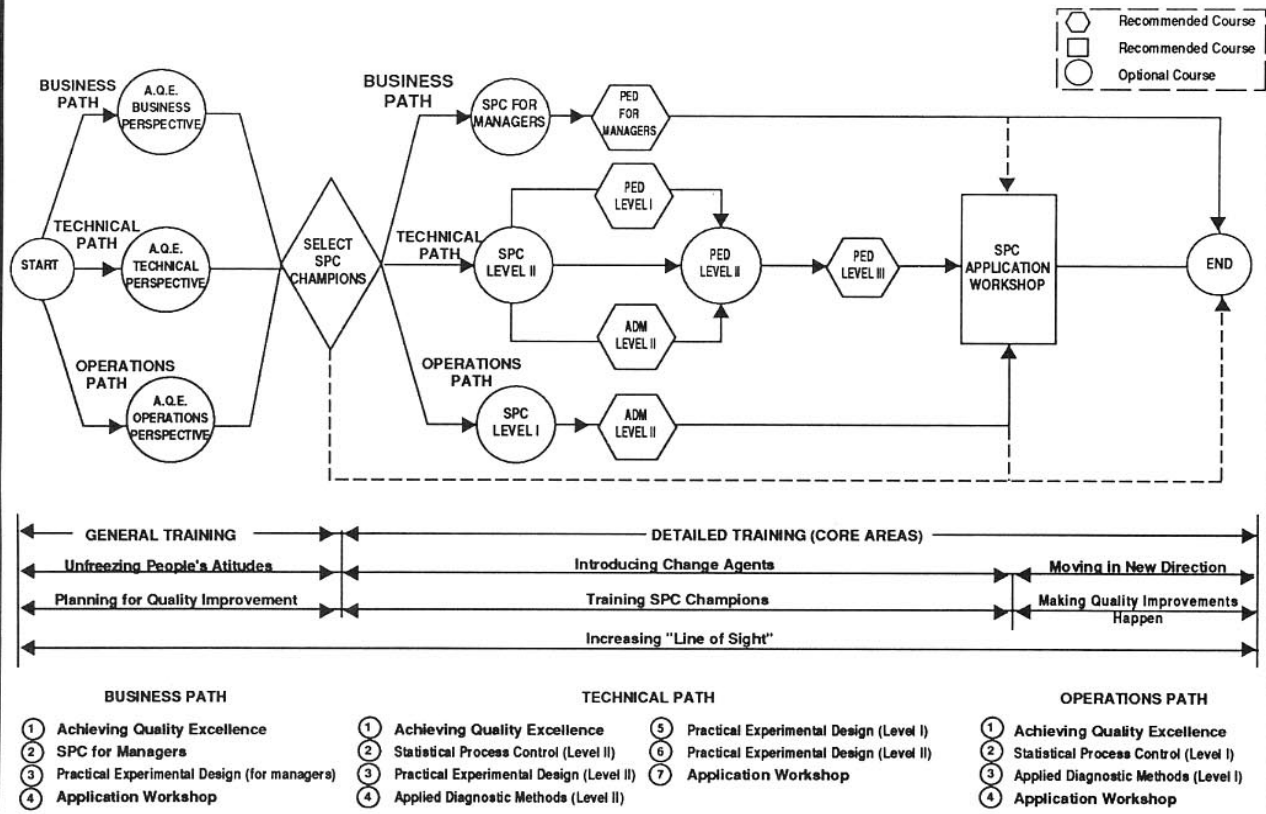
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4.5.6 Examples



SPC training flow and implementation (Reprinted with permission, Ref. HARRY (1986))

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9.2.6 Examples

The figures on this page are examples of cause-effect matrixes.

	NaCl CONTAM	Y ₂	Y ₃	Y ₄	Y ₅	Y ₆	ROW AVERAGE
WAVE SOLDER	B						
AMOUNT OF FLUX SPRAYED ON	A						
FLUX SPECIFIC GRAVITY	A						
W.S. PREHEAT TEMP	A						
DEGREASER	A						
TIME FROM W.S. TO DEGREASE	A						
PROCESS FLOW	A						
ZONE 1 TIME (BOIL)	A						
ZONE 2 TIME (COLD)	A						
AGITATION TIME	A						
DRIP TIME	E						
ZONE 3 TIME (VAPOR)	A						
ZONE 4 TIME (DRY)	A						
TIME FROM DEGREASE TO ALCOHOL	D						
FINAL CLEAN	B						
ALCOHOL SOAK TIME	A						
SCRUB TIME	A						
ALCOHOL SPRAY DIRECTION	A						
ALCOHOL SPRAY DURATION	A						
TIME FROM ALCOHOL TO TEST	D						
COLUMN TOTALS							

	Effect: Product Parameters (Improvement Opportunities)				
	Y ₁	Y ₂	Y ₃	Y ₄	Y _N
X ₁	4	1	---	---	2
X ₂	1	2	1	3	---
X ₃	3	4	2	---	---
X ₄	2	3	---	1	1
X ₅	---	12	---	2	19

Note: The number in each box represents the "consensus based" rank order of each "X" with respect to the corresponding "Y"

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Rating Scale:

- A—Very high importance in relation to the problem/response variable; likely to prove causal.
- B—Important in relation to the problem/response variable; could prove causal.
- C—Some concern in relation to the problem/response variable; might prove somewhat causal.
- D—Little concern in relation to the problem/response variable; likely not to prove causal.
- E—No concern in relation to the problem/response variable; should not prove causal.
- F—Needs to be controlled during the conduct of the experiment.

Fully constructed Cause-and-Effect (C&E) matrix of a generic nature ready for experimental verification (Reprinted with permission Ref. HARRY (1986))

Partially constructed Cause-and-Effect (C&E) matrix (Reprinted with permission Ref. HARRY (1986)).